

General Description

The MAX631, MAX632, and MAX633 are +5V, +12V, and +15V fixed output, step-up DC-DC converters for use in low-power, high-efficiency switching regulator applications. The only external components required are an output filter capacitor and a low-cost inductor. Included on-chip are low battery detection circuitry and a charge pump output for generating a negative voltage in dual-supply applications.

Though most simply used as fixed output regulators, the MAX631/632/633 can also be set for other output voltages by adding an external voltage divider.

Maxim manufactures a broad line of step-up, step-down, and inverting DC-DC converters, with features such as logic-level shutdown, adjustable oscillator frequency, and external MOSFET drive.

Applications

Minimum Component, High-Efficiency DC-DC Converters

Portable Instruments

Rechargeable and Primary Battery Power Conversion

Uninterruptable On-Board Power Supplies

Card Level Multiple Power Conversion

Features

- ◆ Fixed +5V, +12V, +15V Output Voltages
- ◆ Adjustable Output with 2 Resistors
- ♦ 80% Typ Efficiency
- Only 2 External Components
- ♦ Charge Pump for Negative Output
- ♦ 135µA Typ Operating Current

Ordering Information

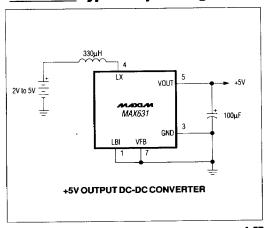
PART*	TEMP. RANGE	PIN-PACKAGE
MAX631XCPA	0°C to +70°C	8 Plastic DIP
MAX631XCSA	0°C to +70°C	8 Narrow SO
MAX631XC/D	0°C to +70°C	Dice
MAX631XEPA	-40°C to +85°C	8 Plastic DIP
MAX631XESA	-40°C to +85°C	8 Narrow SO
MAX631XEJA	-40°C to +85°C	8 CERDIP
MAX631XMJA	-55°C to +125°C	8 CERDIP
MAX632XCPA	0°C to +70°C	8 Plastic DIP
MAX632XCSA	0°C to +70°C	8 Narrow SO
MAX632XC/D	0°C to +70°C	Dice
MAX632XEPA	-40°C to +85°C	8 Plastic DIP
MAX632XESA	-40°C to +85°C	8 Narrow SO
MAX632XEJA	-40°C to +85°C	8 CERDIP
MAX632XMJA	-55°C to +125°C	8 CERDIP

^{*}X = A for 5% Output Accuracy. X = B for 10% Accuracy. Ordering Information continued on last page.

Pin Configuration

Top View LBI 1 LBO 2 MAX631 MAX632 MAX633 LX 4 DIP/SO T VFB MAX633 F VOUT

Typical Operating Circuit



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4-57

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Dual Mode is a trademark of Maxim Integrated Products.

ABSOLUTE MAXIMUM RATINGS

Supply Voltage, VOUT	+18\
Output Voltage, LX and LBO	+18\
Input Voltage, LBI and VFB0.3V to (VOUT -	- 0.3V
LX Output Current	A Peak
LBO Output Current	50mA
Power Dissipation	
Plastic DIP (derate 8.33mW/°C above +50°C) 6	25mW
SO (derate 6mW/°C above +50°C) 4	50mW
CERDIP (derate 8mW/°C above +50°C) 8	00mW

Operating Temperature Range	
MAX63_XC	0°C to +70°C
MAX63_XE	
MAX63_XM	5°C to +125°C
Storage Temperature6	5°C to +160°C
Lead Temperature (Soldering, 10 sec.)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(T_A = +25^{\circ}C, unless otherwise noted.)$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating Voltage Range		Voltage at VOUT Over Temperature (C, E) Over Temperature (M)	2.0 2.4		16.5 16.5	V
Start-up Voltage		Voltage at VOUT TA = +25°C Over Temperature (C, E) Over Temperature (M)	1.5 1.8 2.0	1.3		v
Supply Current	Is	LX off, Over Temperature VOUT= +5V, MAX631 VOUT = +12V, MAX632 VOUT = +15V, MAX633		0.135 0.5 0.75	0.4 2.0 2.5	mA
Reference Voltage (Internal)		T _A = +25°C Over Temperature	1.24 1.20	1.31	1.38 1.42	V
VOUT Voltage		No Load, VFB = GND Over Temperature MAX631A MAX632A MAX633A MAX633B MAX631B MAX632B NO Output Accuracy	4.75 11.4 14.25 4.5 10.8	5.0 12.0 15.0 5.0	5.25 12.6 15.75 5.5 13.2	v
Efficiency		MAX633B J	13.5	15.0 80	16.5	<u> </u>
Line Regulation (Note 1)		+0.5VOUT<+Vs <vout< td=""><td></td><td>0.08</td><td></td><td>%VOUT</td></vout<>		0.08		%VOUT
Load Regulation (Note 1)		Vs = +0.5VOUT, POUT = 0mW to 150mW		0.2		%VOUT
OscillatorFrequency	fo	VOUT = +5V MAX631A MAX631B VOUT = +12V MAX632A MAX632B VOUT = +15V MAX633A MAX633B	40 35 45.5 40 45.5	45 45 50 50	50 60 56 65	kHz
Oscillator Frequency Tempco		IVIAA033B	40	-60	65	Hz/°C
Oscillator Duty Cycle		MAX631, VOUT = +5V MAX632, VOUT = +12V MAX633, VOUT = +15V	40 40 40	50 50 50 50	60 60 60	% %
LX On Resistance	Ron	Ix = 100mA, VOUT = +5V VOUT = +15V		6 3.5	12 7	Ω

ELECTRICAL CHARACTERISTICS (continued)

 $(T_A = +25^{\circ}C, unless otherwise noted.)$

PARAMETER	SYMBOL	CONDITIONS	MIN	TY₽	MAX	UNITS
LX Leakage Current	İxL	V4 = +16.5V TA = +25°C Over Temperature (C, E) Over Temperature (M)		0.01	1.0 30 100	μА
Diode Forward Voltage	VF	IF = 100mA			1.0	V
CP On Resistance		VOUT = +5V, IOUT = ±10mA VOUT = +15V, IOUT = ±30mA		70 30	140	Ω
VFB Input Bias Current	IFB			0.01	10	nA
Low Battery Input Threshold	VLBI			1.31		V
Low Battery Input Bias Current	ILBI			0.01	10	nA
Low Battery Output Current	ILBO	V2 = +0.4V, V1 = +1.1V T _A = +25°C Over Temperature	0.5	1.0		mA
Low Battery Output Leakage Current	ILBOL	V2 = +16.5V, V1 = +1.4V		0.01	3.0	μА

Note 1: Guaranteed by correlation with DC pulse measurements.

Pin Description

PIN	NAME	FUNCTION	
1	LBI	Low Battery Detector Input. When the voltage at LBI is lower than the Low Battery Detector threshold (1.31V), LBO sinks current.	
2	LBO	The Low Battery Detector Output is an open drain N-channel MOSFET which sinks current when LBI is below 1.31V.	
3	GND	Ground	
4	LX	This pin drives the external inductor with an internal N-channel power MOSFET. LX has an output resistance of typically 6Ω and a peak current rating of 425mA.	
5	VOUT	The regulated DC-DC converter output	
6	CP	The Charge Pump output is a low impedance buffer which swings from GND to VOUT at the oscillator frequency. 2 external capacitors and diodes can be connected to generate a negative output voltage (Figure 3).	
7	VFB	When VFB is grounded, the DC-DC con verter output will be the factory preset value. When an external voltage divider is connected from VOUT to VFB and GND, this pin becomes the feedback input for adjustable output operation.	
8	COMP	The Compensation input is connected to the internal voltage divider which sets the fixed voltage output. In some circuit board layouts, a lead compensation capacitor (100pF to 10nF) connected between VOUT and COMP reduces low-frequency ripple and improves transient response.	

_Typical Applications Basic Step-Up Circuits

Figure 1 shows the basic boost or step-up circuit for the MAX631/632/633. The circuit corresponds to Table 1 which shows values for typical input voltages and output currents.

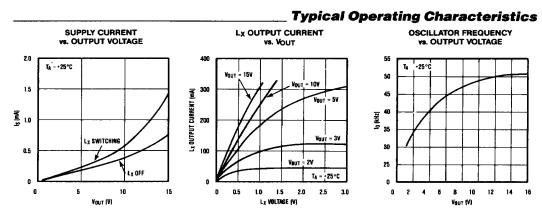
Table 1. Inductor Selection for Common Designs

VIN	VOUT	IOUT	EFF.	INDUCTOR		
(Ÿ)	(V)	(mA)	(%)	P.N. (Note 2)	μ H	Ω
2	5	5	78	CB 6860-21	470	0.4
2	5	10	74	G 1B253	250	0.44
2	5	15	61	G 1B103	100	0.25
3	5	25	82	CB 6860-21	470	0.4
3	5	40	75	CB 7070-29	220	0.55
3	12	5	79	CB 6860-19	330	0.35
3	12	10	79	CB 7070-28	180	0.48
5	12	12	88	CB 6860-21	470	0.4
5	12	25	87	CB 6860-19	330	0.35
3	15	5	73	CB 7070-29	220	0.55
3	15	8	71	CB 7070-27	150	0.43
5	15	10	85	CB 6860-21	470	0.4
5	15	15	85	CB 6860-19	330	0.35
8	15	35	90	G 1B503	500	0.56

Note 2: CB = Cadell-Burns, NY, (516) 746-2310 G = Gowanda Electronics Corp., NY, (716) 532-2234 Other Manufacturers listed in Table 2.

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4-59



Detailed Description

The operation of the MAX631/632/633 can best be understood by examining the regulating loop of Figure 1. When the output voltage drops below the preset (or externally set) value, the Error Comparator switches high and connects the internal 45kHz Oscillator to the gate of the LX output driver, N1. N1 is an N-channel MOSFET with a typical on resistance of 6 Ω and a current rating of 150mA. The following equation provides a good rule of thumb to see if the MAX631/632/633 can provide the desired output current without exceeding the current rating of N1:

$$\frac{8 (VOUT - V_{IN}) IOUT}{V_{IN}} \le 450 \text{mA}$$

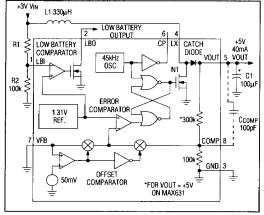


Figure 1. +3V to +5V Converter and Block Diagram

4-60

A low output voltage turns N1 on and off at the internal clock frequency. During each on half-cycle, the current through the inductor rises linearly, storing energy in the coil. During each off half-cycle, the coil's magnetic field collapses and voltage across the inductor reverses sign. The voltage at LX then rises until the internal diode is forward based, delivering power to the output. When the output voltage reaches the desired level, the Error Comparator inhibits N1 until the load discharges the output filter capacitor (C1) to less than the desired output level.

VIN. Bootstrapped Operation

The MAX631/632/633 does not have a $V_{\rm IN}$ pin. Input power to start the DC-DC converter is supplied via the external inductor to the VOUT pin. Once the converter has started, it is then powered from its own output. This 'bootstrap' design ensures that the output MOSFET, N1, will have maximum gate drive and, hence, a minimum RoN. It also allows the converter to start at lower input voltages.

V_{IN}, Greater Than VOUT

If the regulator's input voltage is more than one forward diode drop greater than the desired output voltage, N1 will not turn on. Current will still be supplied to the load directly through the inductor and the internal diode, but without regulation. As long as the input is more than 0.6V above the desired output, the actual output voltage will be equal to the input voltage minus 0.6V.

Fixed or Adjustable Output

For operation at one of the preset output voltages (+5V for the MAX631, +12V for the MAX632, and +15V for the MAX633), VFB is connected to GND, and no external resistors are required. For an output voltage other than the preset value, an external voltage divider (R3 and R4, Figure 2) is required. VOUT is set as follows:

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Let R4 be any resistance in the $10k\Omega$ to $10M\Omega$ range, typically $100k\Omega$, then:

$$R3 = R4 \left(\frac{VOUT}{1.31V} - 1 \right)$$

Table 1 shows nominal inductor parameters for a variety of input and output voltages. Values are given for both maximum output and maximum efficiency designs. When noise is not critical, a low-cost bobbin inductor will suffice. For higher power circuits or when low EMI and noise are required, pot cores and toroids should be used. (See Tables 1 and 2 for typical part numbers and manufacturers.)

Table 2. Coil and Core Manufacturers (Note 3)

MANUFACTURER	TYPICAL PART #	DESCRIPTION			
BOBBIN INDUCTORS					
Dale	IHA-104	500μΗ, 0.5Ω			
Caddell-Burns	7070-29	220μΗ, 0.55Ω			
Gowanda	1B253	250μH, 0.44Ω			
TRW	LL-500	500μΗ, 0.75Ω			
POTTED TOROIDA	AL INDUCTORS				
Dale	TE-3Q4TA	1mH, 0.82Ω			
TRW	MH-1	600μΗ, 1.9Ω			
Gowanda	050AT1003	100μΗ, 0.05Ω			
FERRITE CORES	AND TOROIDS (Note				
Siemens	B64290-K38-X38	Tor. Core, 4µH/T ²			
Magnetics	555.130	Tor. Core, 53nH/T ²			
Stackpole	57-3215	Pot Core, 14mm x 8mm			
Magnetics	G-41408-25 Pot Core, 14 x 8, 250nH				

Note 3: This list does not constitute an endorsement by Maxim Integrated Products and is not intended to be a comprehensive list of all manufacturers of these components.

Note 4: Permag Corp. is a distributor for many of the listed core and toroid manufacturers. (516) 822-3311.

Output Filter Capacitor

The MAX631/632/633's output ripple has 2 components which are 90° out of phase. One component results from the change in the stored charge on the filter capacitor with each LX pulse. The other is the product of the capacitor's charge-discharge current and its Equivalent Series Resistance (ESR). With low-cost aluminum electrolytic capacitors, the ESR produced ripple is often

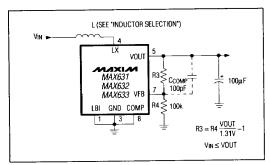


Figure 2. Connections for Adjustable Output

larger than that caused by the change in charge. Consequently, high-quality aluminum or tantalum filter capacitors will minimize output ripple, even if smaller capacitance values are used. Best results at a reasonable cost are typically achieved with a high-quality aluminum electrolytic, in the 100µF to 500µF range, in parallel with a 0.1µF ceramic capacitor.

Catch Diode

The MAX631 series regulators contain an internal "catch" diode and, therefore, require no external diode for most applications. However, an external diode can be connected in parallel with the internal diode at the LX and VOUT pins. For example, a Schottky diode with a low forward voltage drop will provide some improvement in efficiency.

Bypassing and Compensation

Since the inductor charging current can be relatively large, high currents flow through the ground connection to the MAX631/632/633. To prevent unwanted feedback, the impedance of the ground path must be as low as possible, and power-supply bypassing should be used.

When the value of the voltage setting resistors (R3 and R4, Figure 2) exceed $50k\Omega$, stray capacitance at the VFB input can add a "lag" to the feedback response, destablizing the regulator, increasing low frequency ripple, and lowering efficiency. This problem can often be avoided by minimizing lead lengths and circuit board trace size at the VFB node. It can also be remedied by adding a "lead" compensation capacitor (100pF to 10nF) in parallel with R3.

The COMP input allows access to the internal voltage divider so that compensation can also be added when fixed output operation is used. A capacitor connected between VOUT and COMP again adds a "lead" to the regulator's response.

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Low Battery Detector

Negative Output Voltage

The Low Battery Detector compares the voltage on the Low Battery Input, LBI, with the internal 1.31V bandgap reference. The Low Battery Detector Output, LBO, goes low whenever the input voltage at LBI is less than 1.31V. The Low Battery detection voltage is set by resistors, R1 and R2 (Figure 1).

Let R2 be any resistance in the $10k\Omega$ to $10M\Omega$ range, typically $100k\Omega$, then:

$$R1 = R2 \left(\frac{VLB}{1.31V} - 1 \right)$$

(VLB is the desired Low Battery detection voltage)

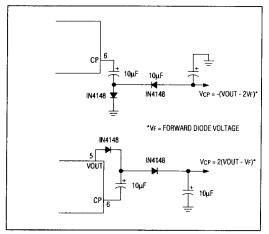


Figure 3. Using the Charge Pump (CP) output as a voltage inverter and/or doubler. Both circuits can be used together.

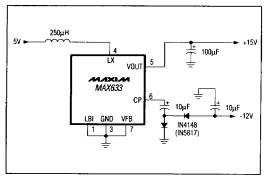


Figure 4. +5V to +15V/-12V Converter

4-62

The Charge Pump (CP) output is a low impedance buffer which swings from ground to VOUT at the oscillator frequency. Two external capacitors and diodes can be connected, as shown in Figure 3, to generate a negative output voltage of –(VOUT – 1.2V) or a positive output of 2(VOUT – 1.2V). 1.2V is the forward drop of 2 silicon diodes. Both circuits can be used at once if desired. With 10µF capacitors, the output impedance of V_{CP} is about 30Ω. If space is critical, the capacitors can be reduced, but with a slight increase in output impedance and V_{CP} output ripple.

The circuit shown in Figure 4 provides approximately ± 10 mA with VOUT = +15V, and ± 15 mA if VOUT = +12V. The magnitude of the negative output is about 3V less than VOUT due to the forward voltage drop of the 1N4148 diodes and the output impedance of CP. Using Schottky diodes (IN5817) will increase the absolute value of the negative output by about 1V. The performance of the CP output is shown in Figure 5.

_What Value of Inductor? A General Discussion

The converters in this data sheet operate by charging an inductor from a DC input and then discharging the inductor to generate a DC output that is greater than the input.

The proper inductor for any DC-DC converter depends on three things: the desired output power, the input voltage (or range of input voltage), and the converter's oscillator frequency and duty cycle. The oscillator timing is important because it determines how long the coil will be charged during each cycle. This, along with the input

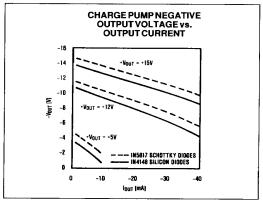


Figure 5. Charge Pump Negative Output Voltage vs. Current

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for lowest ripple.

[] Minimum on resistance of the switch

[1] $I_{pk} = \frac{VOUT + V_{DIODE} - V_{IN}}{(0.25) (V_{IN} - V_{SW})}$ (IOUT)

 $L = \frac{V_{IN} - V_{SW}}{I_{pk}} (t_{ON})$

Low switching frequency (or maximum switch on-

The inductor equations below must be calculated for both

worst-case sets of conditions. The final value chosen

should be between the minimum value and maximum

value calculated. Within these bounds, the value can be

adjusted slightly lower for extra load capability or higher

Where V_{SW} is the voltage drop across the switch in the

on state. Conservatively, the worst case is about 0.75V

Inductor Selection

quately low so efficiency is not affected and self-neating does not occur. Values less than 0.5Ω are usually more	max, 0.25V min with V_{IN} = +15V and 1.5V max, 0.5V min with V_{IN} = +5V.
than adequate. Other inductor parameters, such as core loss or self-resonant frequency, are not a factor at the relatively low MAX631/632/633 operating frequency.	Example: A +5V 10% input must be converted to +15V at 15mA. A Schottky diode (1N5817) and a MAX633B are used.
Inductor Value- Low Enough?	Calculate maximum inductor value allowed:
The problem that bites designs most often, especially in the production or pre-production phase, happens when the inductor value is too high. These units fail to deliver enough load current and exhibit poor load regulation. The worst-case is: [] Maximum load current [] Minimum supply voltage [] Maximum inductor value, including tolerance [] Maximum on resistance of the switch because it reduces the excitation voltage across the inductor	$I_{pk} = \frac{15V + 0.4V - 4.5V}{(0.25)(4.5V - 0.75V)}(15\text{mA}) = 174\text{mA}$ $L = \frac{4.5 - 0.75}{174\text{mA}}(8\mu\text{s}) = 172\mu\text{H}$ Calculate the minimum inductor value allowed: $I_{pk} = 450\text{mA} \text{ (from table of max ratings)}$ $L = \frac{5.5V - 0.25V}{450\text{mA}}(12\mu\text{s}) = 140\mu\text{H}$ If this minimum value is greater than the maximum value
[] Worst-case low on time Inductor Value- High Enough?	calculated above, an external power MOSFET must be used. See the MAX641/642/643 data sheet.
The inductor value must also be high enough so peak currents do not stress the transistor or cause the inductor core to saturate. All kinds of odd symptoms can be traced to excessive inductor currents: low efficiency,	A value of 160μH would be a good choice for this application. The "A" grade devices, with tighter oscillato tolerance, allow more output current in a given application.
rattling heat sinks, whining coils, and increased output ripple. Very low inductor values may result in damaged	Inductor Saturation
power transistors. The slope of the inductor current, and therefore the peak value that it reaches in a given on time, is determined by the supply voltage and the inductor value. The worst case occurs at: [] Maximum supply voltage [] Minimum inductor value, including tolerance	When using off-the-shelf inductors, make sure the peal current rating is observed. When designing your own inductors, observe the core manufacturer's Ampere turns or NI ratings. Failure to observe the peak curren or NI ratings may lead to saturation of the inductor Inductor saturation leads to very high current levels causing excessive power dissipation, poor efficiency, and possible damage to the chip and the catch diode.
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voltage, determines how much energy will be stored in

[] Value- Low enough inductance so it stores ade-

High enough so excessive and potentially destructive

currents are avoided under worst-case conditions for

high power-switch transistor on time and high input voltage.

[] Saturation- The coil must deliver the correct induc-

tance value at the worst-case, high peak operating cur-

[] EMI- Electromagnetic interference must not upset

nearby circuitry or the regulator IC. Ferrite bobbin types work well for digital circuits; toroid or pot core types work

[] DC resistance- Winding resistance must be ade-

well for EMI-sensitive analog circuits.

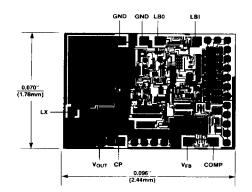
The inductor must meet four electrical criteria:

quate energy at the worst-case, low input voltage.

the coil.

Test for saturation by applying the maximum load and the maximum input voltage while monitoring the inductor current with a current probe. The normal inductor current waveform is a sawtooth with a linear current ramp. Saturation creates a nonlinear current waveform with a very rapid increase in current once the inductor saturates. It is this rapid current increase and the resultant high peak currents that can damage the inductor and the catch diode.

Chip Topography



_ Ordering Information (continued)

PART*	TEMP. RANGE	PIN-PACKAGE
MAX633XCPA	0°C to +70°C	8 Plastic DIP
MAX633XCSA	0°C to +70°C	8 Narrow SO
MAX633XC/D	0°C to +70°C	Dice
MAX633XEPA	-40°C to +85°C	8 Plastic DIP
MAX633XESA	-40°C to +85°C	8 Narrow SO
MAX633XEJA	-40°C to +85°C	8 CERDIP
MAX633XMJA	-55°C to +125°C	8 CERDIP

^{*} X = A for 5% Output Accuracy. X = B for 10% Accuracy.

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4-64 _____